1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 1 A
- Reverse voltage: V_R ≤ 40 V
- Low forward voltage V_F ≤ 600 mV
- Low reverse current
- AEC-Q101 qualified
- · Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package

3. Applications

- Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch mode power supply
- LED backlight for mobile application
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|-------------------------|--|-----|-----|-----|-----|------|
| I _{F(AV)} | average forward current | δ = 0.5 ; f = 20 kHz; $T_{amb} \le 90 ^{\circ}\text{C}$; square wave | [1] | - | - | 1 | Α |
| | | δ = 0.5 ; f = 20 kHz; $T_{sp} \le 135$ °C; square wave | | - | - | 1 | Α |
| V_R | reverse voltage | T _j = 25 °C | | - | - | 40 | V |
| V _F | forward voltage | $I_F = 1 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ pulsed; $T_j = 25 ^{\circ}\text{C}$ | | - | 540 | 600 | mV |
| I _R | reverse current | V _R = 10 V; T _j = 25 °C | | - | 0.6 | 4 | μΑ |



40 V, 1 A low VF MEGA Schottky barrier rectifier

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-----------------------|---|-----|-----|-----|------|
| t _{rr} | reverse recovery time | $I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $T_j = 25 ^{\circ}\text{C}$ | - | 3 | - | ns |

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|---|----------------|
| 1 | K | cathode[1] | | к _} А |
| 2 | А | anode | 1 2 | sym001 |
| | | | Transparent top view DFN1608D-2 (SOD1608) | |

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

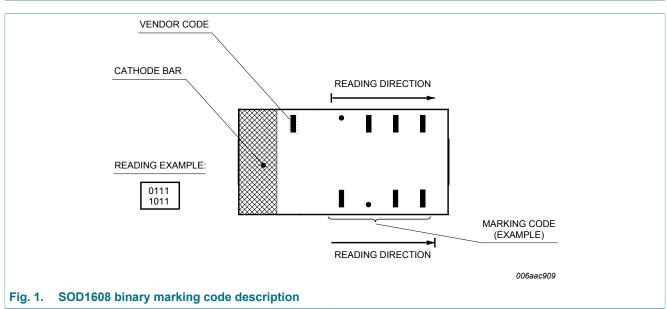
| Type number | Package | | | | |
|-------------|------------|---|---------|--|--|
| | Name | Description | Version | | |
| PMEG4010EPK | DFN1608D-2 | DFN1608D-2: leadless ultra small plastic package; 2 terminals | SOD1608 | | |

40 V, 1 A low VF MEGA Schottky barrier rectifier

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMEG4010EPK | 1010 0000 |



40 V, 1 A low VF MEGA Schottky barrier rectifier

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|-------------------------------------|---|---------|-----|------|------|
| V_R | reverse voltage | T _j = 25 °C | | - | 40 | V |
| l _F | forward current | T _{sp} ≤ 130 °C | | - | 1.4 | Α |
| I _{F(AV)} | average forward current | δ = 0.5 ; f = 20 kHz; $T_{amb} \le 90$ °C; square wave | [1] | - | 1 | Α |
| | | δ = 0.5 ; f = 20 kHz; $T_{sp} \le 135$ °C; square wave | | - | 1 | Α |
| I _{FRM} | repetitive peak forward current | $t_p \le 1 \text{ ms}; \delta \le 0.25$ | | - | 3 | Α |
| I _{FSM} | non-repetitive peak forward current | t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C | | - | 5 | Α |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [2] [3] | - | 410 | mW |
| | | | [4] [3] | - | 860 | mW |
| | | | [1] [3] | - | 1565 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Reflow soldering is the only recommended soldering method.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------|--|------------|----------------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to | | [1] [2] [3] | - | - | 305 | K/W |
| | ambient | | [1] [4] [3] | - | - | 145 | K/W |
| | | | [1] [5] [3] | - | - | 80 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [6] | - | - | 20 | K/W |

^[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

PMEG4010EPK

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[3] Reflow soldering is the only recommended soldering method.

^[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

^[5] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

^[6] Soldering point of cathode tab.

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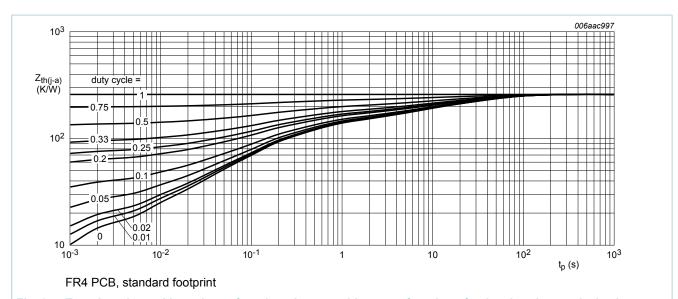


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

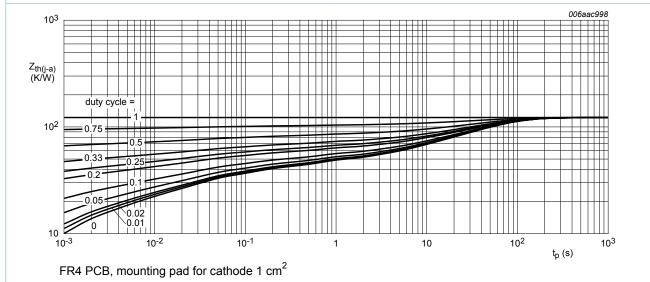
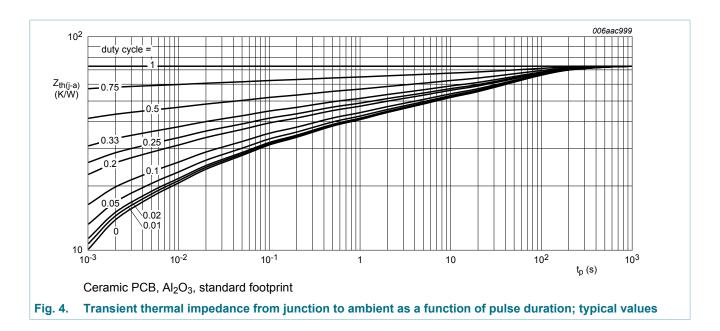


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

40 V, 1 A low VF MEGA Schottky barrier rectifier

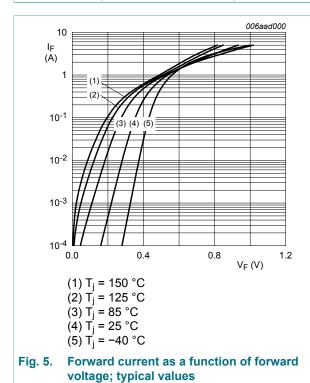


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10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|-------------------------------|---|-----|-----|-----|------|
| V _F | forward voltage | I_F = 100 mA; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; pulsed; T_j = 25 °C | - | 345 | 390 | mV |
| | | I_F = 500 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_j = 25 °C | - | 440 | 500 | mV |
| | | I_F = 700 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_j = 25 °C | - | 480 | 550 | mV |
| | | $I_F = 1 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ pulsed; $T_j = 25 ^{\circ}\text{C}$ | - | 540 | 600 | mV |
| I _R reverse | reverse current | V _R = 10 V; T _j = 25 °C | - | 0.6 | 4 | μA |
| | | V _R = 40 V; T _j = 25 °C | - | 3 | 20 | μΑ |
| C _d | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | - | 50 | 60 | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | - | 20 | 25 | pF |
| t _{rr} | reverse recovery time | $I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $I_{j} = 25 \text{ °C}$ | - | 3 | - | ns |
| V_{FRM} | peak forward recovery voltage | $I_F = 0.5 \text{ A}$; $dI_F/dt = 20 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$ | - | 460 | - | mV |



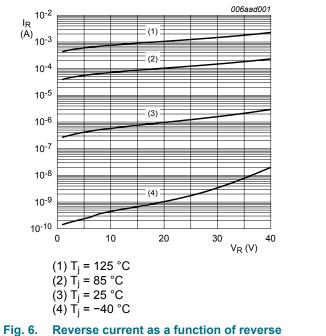


Fig. 6. Reverse current as a function of reverse voltage; typical values

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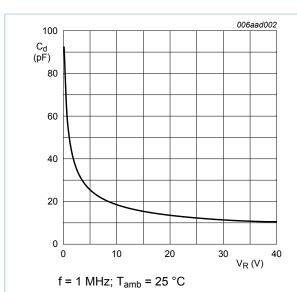


Fig. 7. Diode capacitance as a function of reverse voltage; typical values

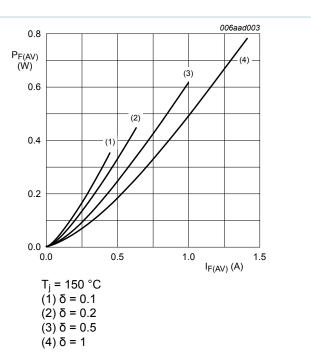


Fig. 8. Average forward power dissipation as a function of average forward current; typical values

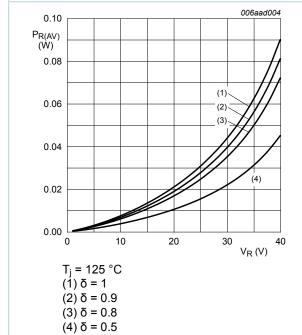


Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values

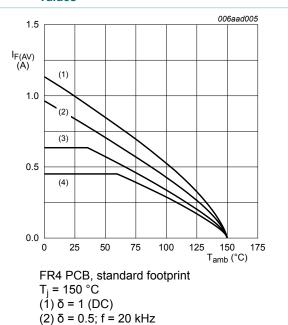
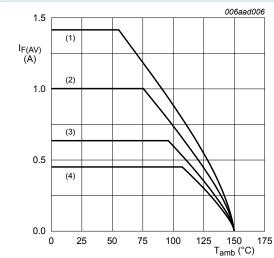


Fig. 10. Average forward current as a function of ambient temperature; typical values

(3) $\delta = 0.2$; f = 20 kHz(4) $\delta = 0.1$; f = 20 kHz

40 V, 1 A low VF MEGA Schottky barrier rectifier



FR4 PCB, mounting pad for cathode 1 cm^2

T_i = 150 °C

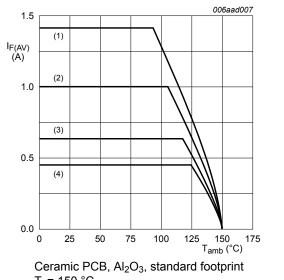
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



 $T_i = 150 \, ^{\circ}C$

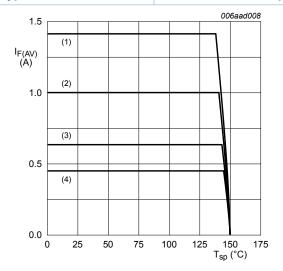
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



 T_j = 150 °C

 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

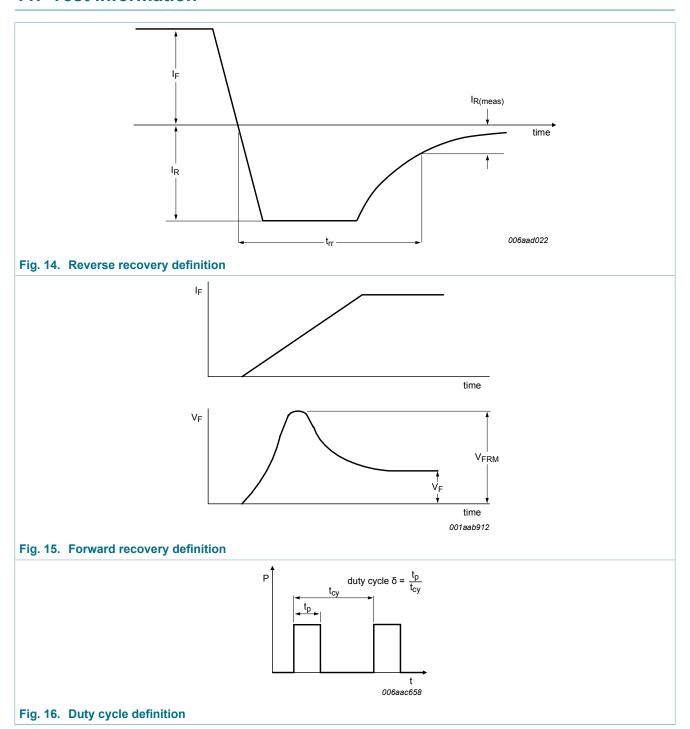
(4) δ = 0.1; f = 20 kHz

Fig. 13. Average forward current as a function of solder point temperature; typical values

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11. Test information



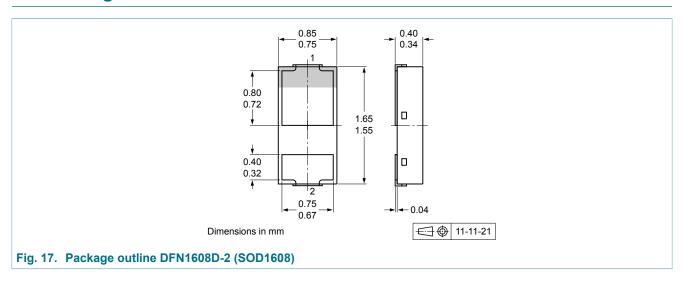
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

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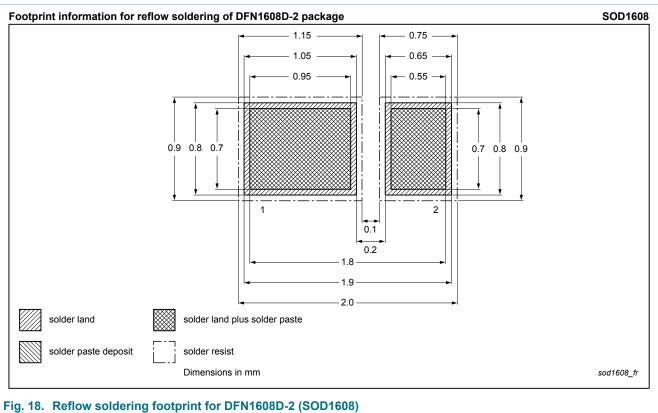
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision history

| | - J | | | | | | |
|-----------------|--|--------------------|---------------|---------------|--|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | |
| PMEG4010EPK v.3 | 20180118 | Product data sheet | - | PMEG4010EPK_2 | | | |
| Modifications: | The format of this datasheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. | | | | | | |
| PMEG4010EPK_2 | 20120306 | Product data sheet | - | PMEG4010EPK_1 | | | |
| PMEG4010EPK_1 | 20120302 | Product data sheet | - | - | | | |

40 V, 1 A low VF MEGA Schottky barrier rectifier

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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